### Supplementary Material for

# **Development of a Semiconducting Supramolecular Copper(II)-Metallogel for Antimicrobial and Microelectronic Device Applications**

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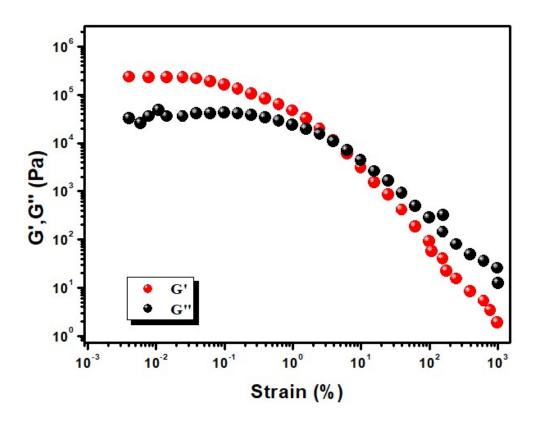
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# **Table of Content**

Rheological Analysis	3
Optical Property	3-4
Thermionic emission theory	4
References	5

#### **Rheological Analysis:**

The strain-sweep experiment, performed at a constant angular frequency of 6.283 rad/s, provided insights into the gel's mechanical response under varying strain conditions. The results, depicted in Fig. S1, highlight the Cu-IPA metallogel's ability to maintain its structure and mechanical integrity within specific strain limits, further emphasizing its high tolerance and gel stability.



**Fig. S1.** Strain-sweep measurements of Cu-IPA metallogel performed at a constant frequency of 6.283 rad/sec.

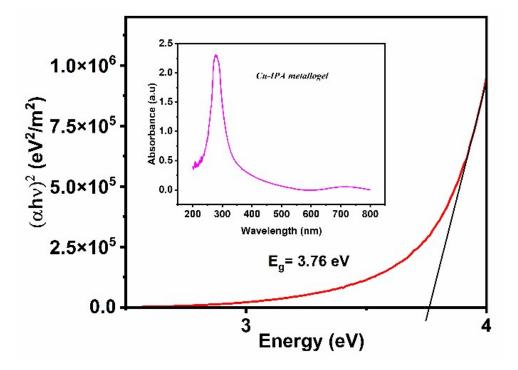
#### **Optical Property:**

In order to ascertain the optical band gap, the optical absorbance spectra of the synthesized metallogel were measured. The UV-Vis absorption spectrum of the synthesized material between 200 and 800 nano-meters is shown in Fig. S2 inset. The metallogel's direct optical band gap energy is determined using Tauc's equation<sup>1</sup>

$$(\alpha h v)^2 = c(hv - E_g)$$
(S1)

where  $\alpha$  is the absorption coefficient,  $E_g$  is the optical band gap energy, h is Planck's constant, v is frequency and c refer a constant. The band gap energy due to direct allowed

transitions in the metallogel is estimated as 3.76 eV (Fig. S2) considering highest absorption edge in Tauc's plot.



**Fig. S2.** Tauc's plot to evaluate the direct allowed band gap energy and (inset) UV-Vis absorption spectra of the metallogel.

#### Thermionic emission theory:

For the very purpose the following equations of thermionic emission is employed where series resistance of the configuration is also taken into consideration.<sup>2</sup>

$$I = I_{sat} \left( e^{\frac{q(V-IR_s)}{\eta kT}} - 1 \right)$$
(S2)

Where  $I_{sat}$  represents the saturation current density, q is the electronic charge, V symbolizes the voltage across the diode, n is the ideality factor, k denotes the Boltzmann constant and T is the absolute temperature.  $IR_s$  is the voltage drop across the configuration with a series resistance of  $R_s$ . The saturation current density  $I_{sat}$  can be expressed as:

$$I_{sat} = AA^*T^2 e^{\frac{-q\phi_b}{kT}}$$
(S3)

Where A\* is the effective Richardson constant and  $^{\emptyset_b}$  is the formed barrier height between Al/Cu-IPA-metallogel interface. Here, the effective diode area is considered as 7.065 ×10<sup>-6</sup> m<sup>2</sup>. The effective Richardson constant is taken as 1.201 ×10<sup>6</sup> AK<sup>-2</sup>m<sup>-2</sup> using standard value of the constant.

### **Reference:**

- 1. A. Dolgonos, T. O. Mason and K. R. Poeppelmeier, *J. Solid State Chem.*, 2016, **240**, 43-48.
- P. Das, B. Pal, J. Datta, M. Das, S. Sil and P. P. Ray, J. Phys. Chem. Solids, 2021, 148, 109706.